

HVM27WK

Variable Capacitance Diode for FM tuner

REJ03G0101-0400Z

(Previous: ADE-208-060C)

Rev.4.00

Sep.29.2003

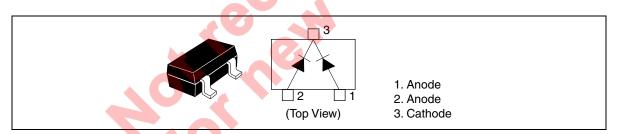
Features

- High capacitance ratio to wide tuning band width. $(C_1/C_8 = 1.8 \text{ min})$
- Low series resistance.
- MPAK package is suitable for high density surface mounting and high speed assembly.

Ordering Information

Type No.	Laser Mark	Package Code
HVM27WK	T5	MPAK

Pin Arrangement



Absolute Maximum Ratings *1

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Reverse voltage	V_{R}	20	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-55 to +125	°C

Note: 1. Per one device.

Electrical Characteristics *3

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse voltage	$V_{_{\mathrm{R}}}$	20	_	_	V	$I_R = 10 \mu A$
Reverse current	I _R	_	_	50	nA	V _R = 15 V
Capacitance	C ₁	52.0	_	62.0	pF	$V_R = 1 \text{ V, f} = 1 \text{ MHz}$
	C ₂	43.0		48.1		V _R = 2 V, f = 1 MHz
	C ₈	24.0		28.0		V _R = 8 V, f = 1 MHz
Capacitance ratio	n ₁	1.8				C ₁ /C ₈
	n ₂	1.7	7	7		C ₂ /C ₈
Series resistance	r _s	-	_	0.4	Ω	V _R = 2 V, f = 100 MHz
Matching error	ΔC/C *1	_		3.0	%	V _R = 1 to 8 V, f = 1 MHz

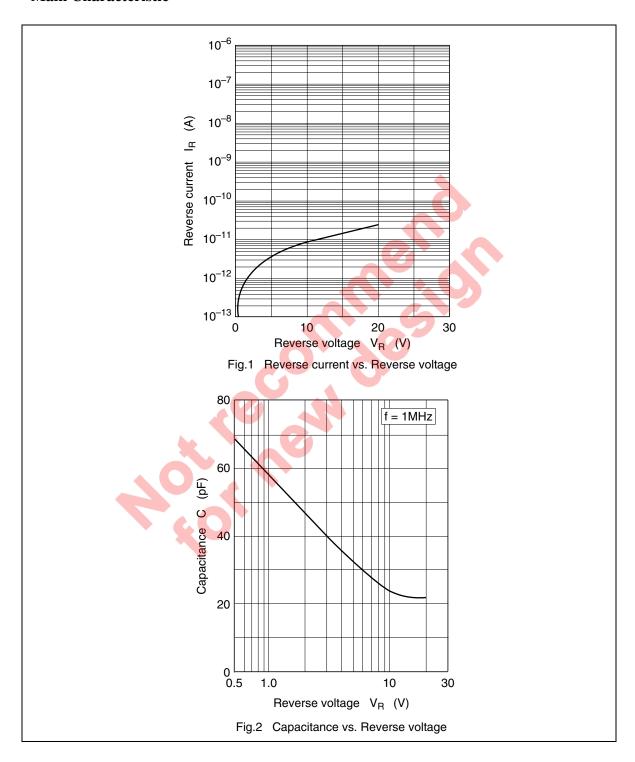
Notes: 1. A set of HVM27WK is of uniform C-V characteristics.

Measure max. value and min. value of capacitance at each bias point of $V_R = 1 \text{ V}$ through 8 V. Calculate Matching Error,

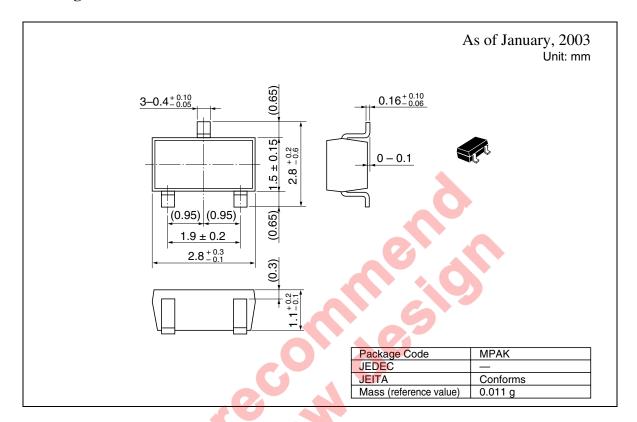
$$\Delta C/C = \frac{(Cmax - Cmin)}{Cmin} \times 100 (\%)$$

- 2. Each group shall uniform a multiple of 4 diodes.
- 3. Per one device.

Main Characteristic



Package Dimensions



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